



ALPHA & OMEGA
SEMICONDUCTOR



AO4822A

Dual N-Channel Enhancement Mode Field Effect Transistor

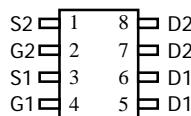
General Description

The AO4822A uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications. Standard Product AO4822A is Pb-free (meets ROHS & Sony 259 specifications).

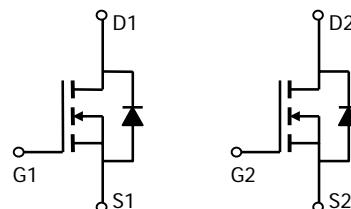
AO4822AL is a Green Product ordering option.
AO4822A and AO4822AL are electrically identical.

Features

V_{DS} (V) = 30V
 I_D = 8.5A (V_{GS} = 10V)
 $R_{DS(ON)} < 16m\Omega$ (V_{GS} = 10V)
 $R_{DS(ON)} < 26m\Omega$ (V_{GS} = 4.5V)



SOIC-8



Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^A	I_D	8.5	A
$T_A=70^\circ C$		6.6	
Pulsed Drain Current ^B	I_{DM}	30	
Power Dissipation	P_D	2	W
$T_A=70^\circ C$		1.28	
Junction and Storage Temperature Range	T_J , T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	48	62.5	°C/W
Steady-State		74	110	°C/W
Maximum Junction-to-Lead ^C	$R_{\theta JL}$	35	40	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=24\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$		1	5	μA
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$		100		nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1	1.7	3	V
$I_{\text{D(ON)}}$	On state drain current	$V_{GS}=10\text{V}, V_{DS}=5\text{V}$	30			A
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=8.5\text{A}$ $T_J=125^\circ\text{C}$	13.4	16		$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=6\text{A}$	20	25		$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{DS}=5\text{V}, I_D=8.5\text{A}$		23		S
V_{SD}	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.75	1	V
I_S	Maximum Body-Diode Continuous Current			3		A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$		955	1250	pF
C_{oss}	Output Capacitance			145		pF
C_{rss}	Reverse Transfer Capacitance			112		pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		0.5	0.85	Ω
SWITCHING PARAMETERS						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, I_D=8.5\text{A}$		17	24	nC
$Q_g(4.5\text{V})$	Total Gate Charge			9	12	nC
Q_{gs}	Gate Source Charge			3.4		nC
Q_{gd}	Gate Drain Charge			4.7		nC
$t_{\text{D(on)}}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, R_L=1.8\Omega, R_{\text{GEN}}=3\Omega$		5	6.5	ns
t_r	Turn-On Rise Time			6	7.5	ns
$t_{\text{D(off)}}$	Turn-Off Delay Time			19	25	ns
t_f	Turn-Off Fall Time			4.5	6	ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=8.5\text{A}, dI/dt=100\text{A}/\mu\text{s}$		16.7	21	ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=8.5\text{A}, dI/dt=100\text{A}/\mu\text{s}$		6.7	10	nC

A: The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The value in any given application depends on the user's specific board design. The current rating is based on the $t \leq 10\text{s}$ thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C: The $R_{\theta JA}$ is the sum of the thermal impedance from junction to lead $R_{\theta JL}$ and lead to ambient.

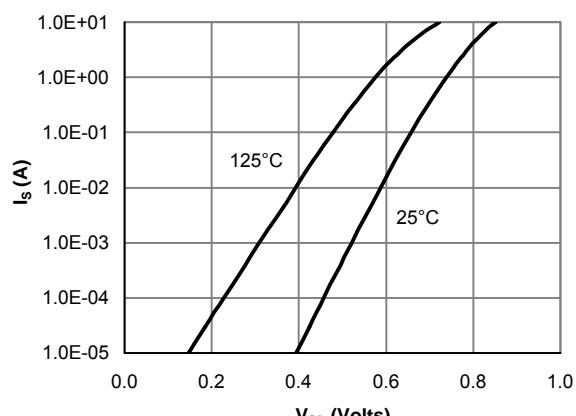
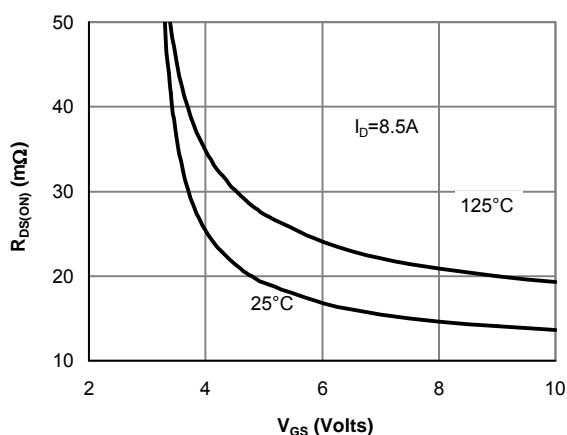
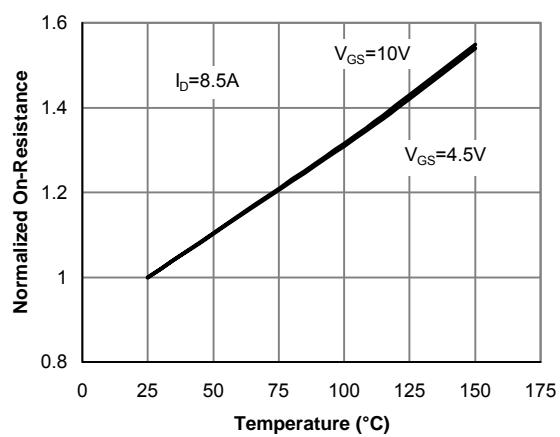
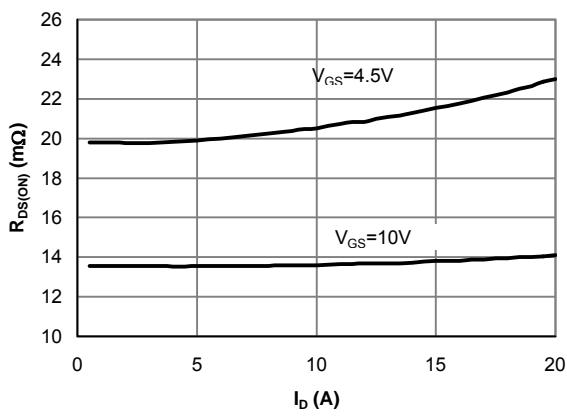
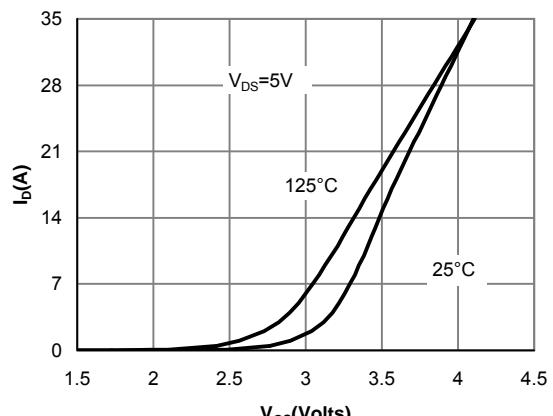
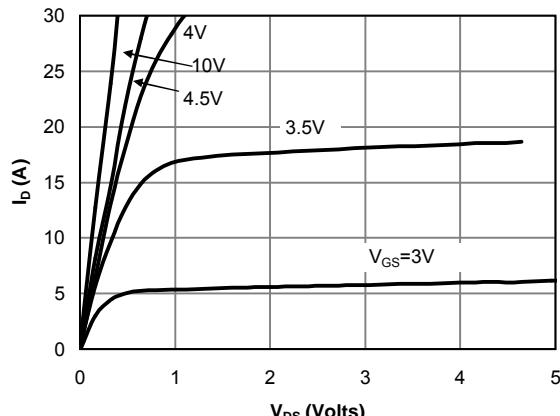
D: The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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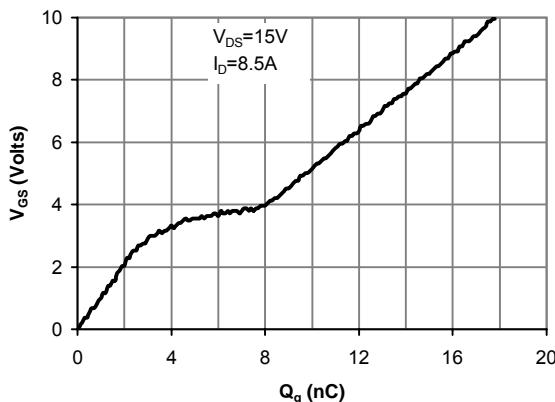


Figure 7: Gate-Charge Characteristics

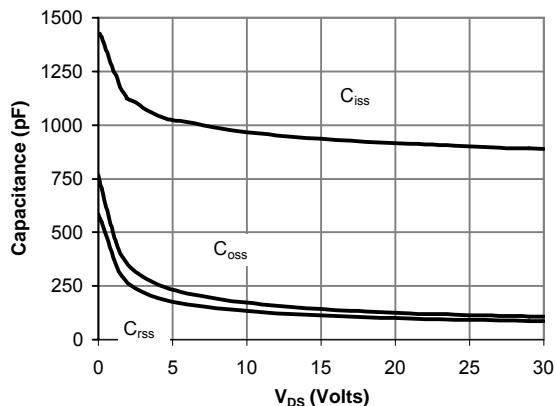


Figure 8: Capacitance Characteristics

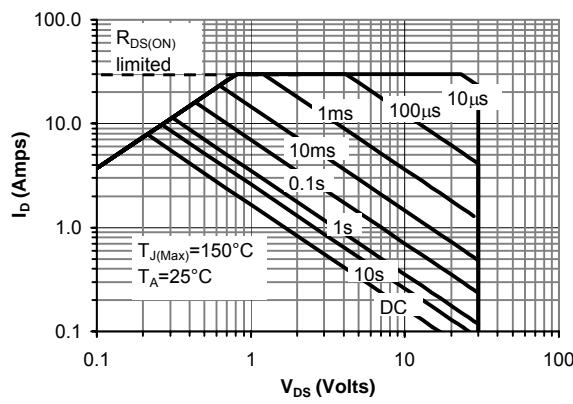


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

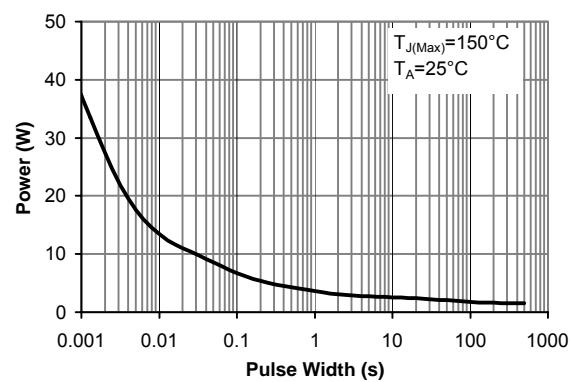


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

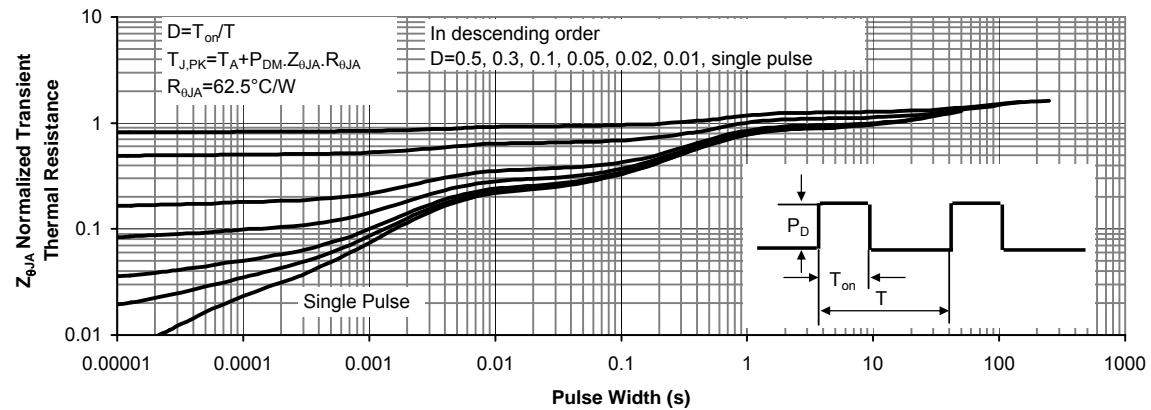


Figure 11: Normalized Maximum Transient Thermal Impedance